HALOGEN FREE

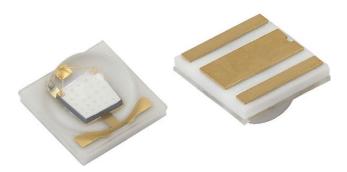
GREEN

(5-2008)



## Vishay Semiconductors

### **UV SMD LED With Silicone Lens**



### **DESCRIPTION**

VLMU3520-...-120 series is a ceramic based high power UV LED with silicone lens for long life time. The package size is 3.5 mm x 3.5 mm and the radiant power up to 2 W at 1200 mA in a wavelength range of 380 nm to 410 nm.

### PRODUCT GROUP AND PACKAGE DATA

• Product group: LED

Package: SMD ceramic high powerProduct series: high power UV LED

• Angle of half intensity: ± 60°

• Lead-finishing: Au

### **SAFETY ADVICES**

UV LEDs emit highly concentrated, non visible UV light which can be harmful to the human eye. Do not expose the eyes or skin directly to the UV light. Wear appropriate protective gear when operating the LED. Keep out of the reach of children.

#### **FEATURES**

• Ceramic SMT package with silicone lens

• Dimension (L x W x H) in mm: 3.5 x 3.5 x 2.2

• Forward current: up to 1250 mA

• Radiant power (typ.): 930 mW at 500 mA

· Materials:

- Die: InGaN

- Resin: silicone (water clear)

- Leads / terminations finish: gold plated (Au)

· Grouping parameters:

- Radiant power

- Peak wavelength

- Forward voltage

· Reflow soldering method

MSL2 according to J-STD-020

 Packaging: 12 mm tape on reel, Ø 180 mm (7"), 500 pcs per reel

 Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

### **APPLICATIONS**

- · Industrial curing
- Photocatalytic purification
- · Poster printing curing
- · Counterfeit money detector
- Blood detector
- Nail curing
- Teeth curing

PARTS TABLE														
PART	COLOR	RADIANT POWER (mW)		at I <sub>F</sub>	(nm)		at I <sub>F</sub>	FORWARD VOLTAGE (V)		at I <sub>F</sub>	TECHNOLOGY			
		MIN.	TYP.	MAX.	(mA)	MIN.	TYP.	MAX.	(mA)	MIN.	TYP.	MAX.	(mA)	
VLMU3520-385-120	Ultraviolet	780	930	-	500	380	385	390	500	3.2	3.6	4.0	500	InGaN
VLMU3520-395-120	Ultraviolet	780	930	-	500	390	395	400	500	3.2	3.6	4.0	500	InGaN
VLMU3520-405-120	Ultraviolet	780	930	-	500	400	405	410	500	3.2	3.6	4.0	500	InGaN



<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_{amb} = 25$ °C, unless otherwise specified) <b>VLMU3520120</b>							
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT			
DC forward current		I <sub>F</sub>	1250	mA			
Pulse forward current	Duty cycle 1/10, pulse width 0.1 ms	I <sub>FP</sub>	1500	mA			
Power dissipation		$P_V$	5	W			
Electrostatic discharge	HBM: MIL-STD-883 C 3B	ESD	8000	V			
Junction temperature		Tj	+130	°C			
Operating temperature range		T <sub>amb</sub>	-40 to +105	°C			
Storage temperature range		T <sub>stg</sub>	-40 to +105	°C			
Solder temperature		T <sub>sol</sub>	260	°C			
Thermal resistance - junction to solder point		R <sub>thJS</sub>	10	K/W			

<b>OPTICAL AND ELECTRICAL CHARACTERISTICS</b> ( $T_{amb} = 25$ °C, unless otherwise specified) <b>VLMU3520120, ULTRAVIOLET</b>								
PARAMETER	TEST CONDITION	DEVICE TYPE	SYMBOL	MIN.	TYP.	MAX.	UNIT	
Forward voltage	I <sub>F</sub> = 500 mA		V <sub>F</sub>	3.2	3.6	4	V	
Radiant power	I <sub>F</sub> = 500 mA	VLMU3520120	φ <sub>e</sub>	780	930	-	mW	
Radiant power	I <sub>F</sub> = 1200 mA	VLMU3520120	φ <sub>e</sub>	-	2000	-	mW	
Ratio of radiant intensity / radiant power	I <sub>F</sub> = 500 mA	VLMU3520120	$l_e/\Phi_e$	-	0.31	-	sr <sup>-1</sup>	
	I <sub>F</sub> = 500 mA	VLMU3520-385-120	$\lambda_{p}$	380	385	390	nm	
Peak wavelength		VLMU3520-395-120		390	395	400	nm	
		VLMU3520-405-120		400	405	410	nm	
		VLMU3520-385-120		-	13	-	nm	
Spectral bandwidth at 50 % $\Phi_{\text{rel.}}$ max.	I <sub>F</sub> = 500 mA	VLMU3520-395-120	$\Delta\lambda_{0.5}$	-	15	-	nm	
		VLMU3520-405-120		-	18	-	nm	
Angle of half intensity	I <sub>F</sub> = 500 mA		φ	-	± 60	-	0	
Reverse current	V <sub>R</sub> = 5 V		I <sub>R</sub>	-	-	10	μΑ	

### Note

• Tolerances:  $\pm$  11 % for  $\varphi_e,\,\pm$  0.1 V for  $V_F,\,\pm$  1 nm for  $\lambda_p$ 

<b>RADIANT POWER CLASSIFICATION</b> ( $I_F = 500 \text{ mA}$ )							
GROUP	MIN.	MAX.	UNIT				
U078	780	820					
U082	820	860					
U086	860	900	\/				
U090	900	940	mW				
U094	940	980					
U098	980	1020					

PEAK WAVELENGTH CLASSIFICATION ( $I_F = 500 \text{ mA}$ )						
GROUP	MIN.	MAX.	UNIT			
Q380	380	385				
Q385	385	390				
Q390	390	395	nm			
Q395	395	400	nm			
Q400	400	405				
Q405	405	410				



FORWARD VOLTAGE CLASSIFICATION ( $I_F = 500 \text{ mA}$ )						
GROUP	MIN.	MAX.	UNIT			
V3234	3.2	3.4				
V3436	3.4	3.6	V			
V3638	3.6	3.8	V			
V3840	3.8	4.0	1			

#### Note

In order to ensure availability, single groups for radiant intensity, wavelength, and forward voltage will not be orderable. Only one group for
radiant intensity, wavelength, and forward voltage will be shipped in any one reel

### MARKING EXAMPLE FOR SELECTION CODE ON LABEL

Selection code: U090Q385V3436 • U090:  $\phi_e$ , range 900 mW to 940 mW • Q385:  $\lambda_p$ , range 385 nm to 390 nm • V3436:  $V_F$ , range 3.4 V to 3.6 V

### TYPICAL CHARACTERISTICS (T<sub>amb</sub> = 25 °C, unless otherwise specified)

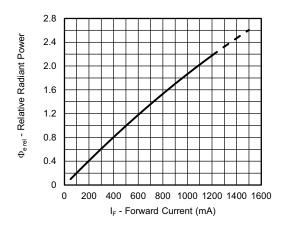


Fig. 1 - Relative Radiant Power vs. Forward Current

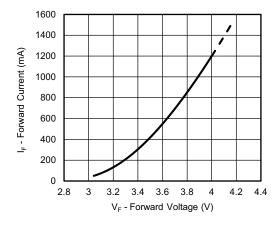


Fig. 2 - Forward Current vs. Forward Voltage

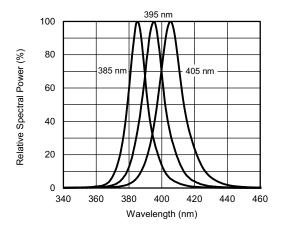


Fig. 3 - Relative Spectral Power vs. Wavelength

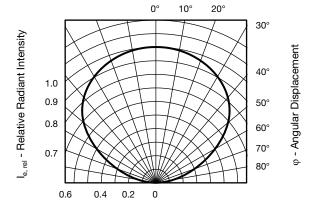


Fig. 4 - Relative Radiant Intensity vs. Angular Displacement



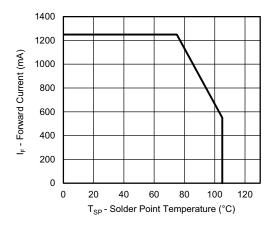


Fig. 5 - Maximum Forward Current vs. Solder Point Temperature

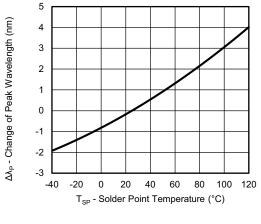


Fig. 7 - Change of Peak Wavelength vs. Solder Point Temperature

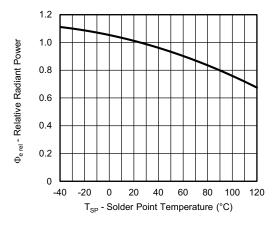


Fig. 6 - Relative Radiant Power vs. Solder Point Temperature

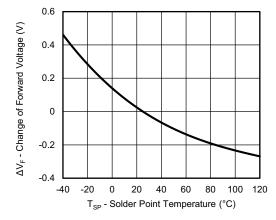
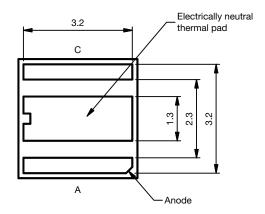
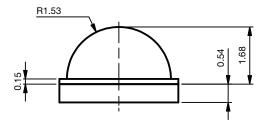


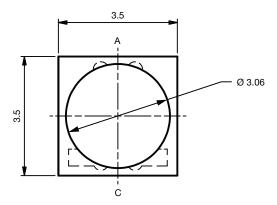
Fig. 8 - Change of Forward Voltage vs. Solder Point Temperature

### **PACKAGE DIMENSIONS** in millimeters



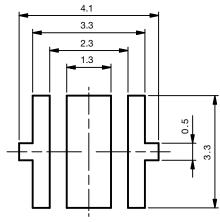






Drawing-No.: 6.541-5107.02-4 Issue: 1VK; 01.10.2020

### Recommended solder pad footprint



Not indicated tolerances  $\pm$  0.13

### **WIRING**

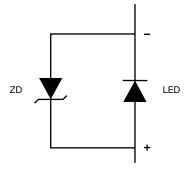
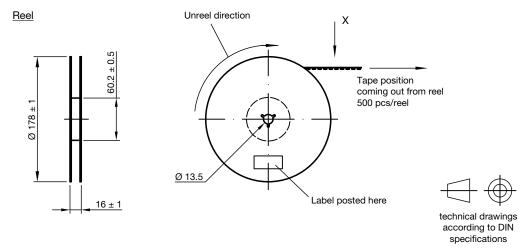


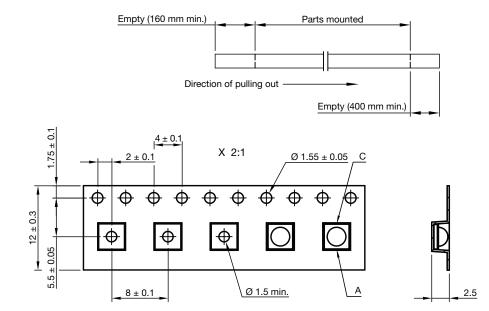
Fig. 9 - Wiring Diagram



### TAPE AND REEL DIMENSIONS in millimeters



### Leader and trailer tape



Drawing-No.: 9.800-5130.01-4

Issue: 2VK; 26.11.19



### HANDLING RECOMMENDATIONS

In order to achieve excellent lifetime, the package of these UV-LEDs consists of a ceramic substrate in combination with a UV stable silicone as lens material. Compared to standard materials silicone is generally softer and it tends more to attract dust:

- Minimize the level of dirt and dust particles in contact with the LED
- Small amounts of particles on the LEDs, although noticeable from a cosmetic point of view, do not affect the performance in terms of brightness, reliability and quality
- If cleaning is required, a short rinsing with isopropyl alcohol, not longer than 15 seconds, is recommended. Do not use ultrasonic cleaning, it may damage the LED
- Do not apply mechanical stress on the silicone lens
- Avoid any piercing of the silicone lens by sharp objects
- It is recommended to use a suitable pick and place tool for the removal of the LED from blister tape without applying stress to the lens. The recess of the pick-up needle has to be larger than the silicone lens
- For manual handling using tweezers make sure that the LED will be touched carefully at the sidewall of the ceramic substrate, but not at the silicone lens

### **SOLDERING PROFILE**

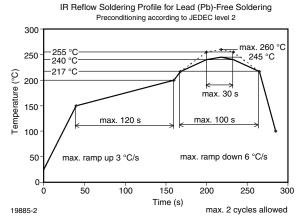
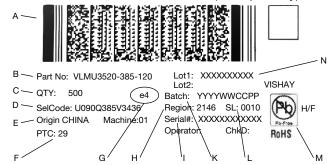


Fig. 10 - Vishay Lead (Pb)-free Reflow Soldering Profile (acc. to J-STD-020C)

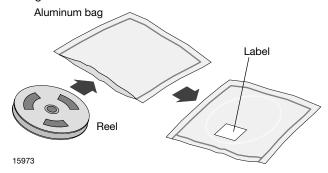
### BAR CODE PRODUCT LABEL (example only)



- A. 2D barcode
- B. Part no: Vishay part number
- C. QTY: quantity
- D. SelCode: selection bin code
- E. Country of origin
- F. PTC: production plant code
- G. Termination finish
- H. Region code
- I. Serial#: serial number
- K. Batch number: year, week, country code, plant code
- L. SL: sales location
- M. Environmental symbols: RoHS, lead (Pb)-free, halogen free
- N. Lot numbers

### **DRY PACKING**

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



### FINAL PACKING

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.



### **RECOMMENDED METHOD OF STORAGE**

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 1 year under these conditions moisture content will be too high for reflow soldering.

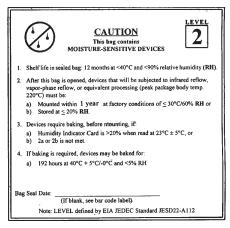
In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or

24 h at 60 °C + 5 °C and < 5 % RH for all device containers or

24 h at 100 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC® standard JESD22-A112 level 2 label is included on all dry bags.



Example of JESD22-A112 level 2 label

### **ESD PRECAUTION**

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

# VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



## **Legal Disclaimer Notice**

Vishay

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